

Four-Bit Universal Shift Register

Description

The MC10H141 is a four-bit universal shift register. This device is a functional/pinout duplication of the standard MECL 10K™ part with 100% improvement in propagation delay and operation frequency and no increase in power supply current.

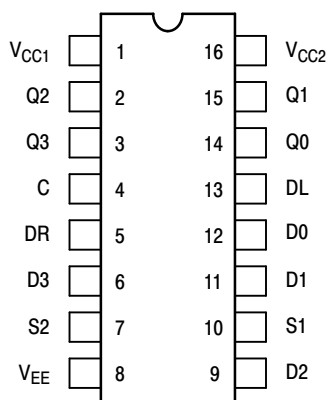
Features

- Shift frequency, 250 MHz Min
- Power Dissipation, 425 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K Compatible
- Pb-Free Packages are Available*

Table 1. TRUTH TABLE

SELECT		OPERATING MODE	OUTPUTS			
S1	S2		Q0 _{n+1}	Q1 _{n+1}	Q2 _{n+1}	Q3 _{n+1}
L	L	Parallel Entry	D0	D1	D2	D3
L	H	Shift Right*	Q1 _n	Q2 _n	Q3 _n	DR
H	L	Shift Left*	DL	Q0 _n	Q1 _n	Q2 _n
H	H	Stop Shift	Q0 _n	Q1 _n	Q2 _n	Q3 _n

* Outputs as exist after pulse appears at "C" input with input conditions as shown (Pulse Positive transition of clock input).



Pin assignment is for Dual-in-Line Package.

Figure 1. Pin Assignment

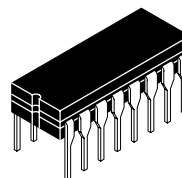
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



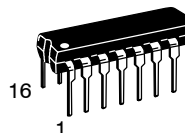
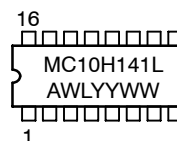
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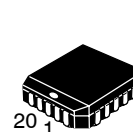
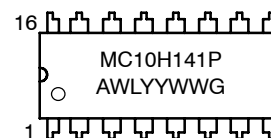
MARKING DIAGRAMS*



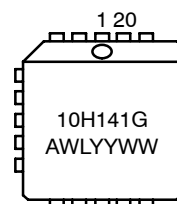
CDIP-16
L SUFFIX
CASE 620A



PDIP-16
P SUFFIX
CASE 648



PLLCC-20
FN SUFFIX
CASE 775



A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

MC10H141

Table 2. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V_{EE}	Power Supply ($V_{CC} = 0$)	-8.0 to 0	Vdc
V_I	Input Voltage ($V_{CC} = 0$)	0 to V_{EE}	Vdc
I_{out}	Output Current – Continuous – Surge	50 100	mA
T_A	Operating Temperature Range	0 to +75	°C
T_{stg}	Storage Temperature Range – Plastic – Ceramic	-55 to +150 -55 to +165	°C °C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Table 3. ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 \text{ V} \pm 5\%$ (Note 1))

Symbol	Characteristic	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
I_E	Power Supply Current	–	112	–	102	–	112	mA
I_{inH}	Input Current High							μA
	Pins 5,6,9,11,12,13	–	405	–	255	–	255	
	Pins 7,10	–	416	–	260	–	260	
	Pin 4	–	510	–	320	–	320	
I_{inL}	Input Current Low	0.5	–	0.5	–	0.3	–	μA
V_{OH}	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V_{OL}	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V_{IH}	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V_{IL}	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

1. Each MECL 10H™ series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50 Ω resistor to -2.0 V.

Table 4. AC PARAMETERS

t_{pd}	Propagation Delay	1.0	2.0	1.0	2.0	1.1	2.1	ns
t_{hold}	Hold Time – Data, Select	1.0	–	1.0	–	1.0	–	ns
t_{set}	Set-up Time							ns
	Data Select	1.5 3.0	– –	1.5 3.0	– –	1.5 3.0	– –	
t_r	Rise Time	0.5	2.4	0.5	2.4	0.5	2.4	ns
t_f	Fall Time	0.5	2.4	0.5	2.4	0.5	2.4	ns
f_{shift}	Shift Frequency	250	–	250	–	250	–	MHz

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

LOGIC DIAGRAM

The logic diagram illustrates a 4-bit parallel shift register. It features a 1 of 4 decoder (74164) with inputs S1 and S2, and a clock input DR. The decoder's four outputs are labeled D3 (PARALLEL ENTER), D2, D1, and D0. These outputs are connected to the D inputs of four D-type flip-flops (7474). The flip-flops are labeled Q3, Q2, Q1, and Q0. The clock input DR is connected to the clock input of all four flip-flops. The output of the first flip-flop (Q3) is connected to the D input of the second flip-flop (Q2). The output of the second flip-flop (Q2) is connected to the D input of the third flip-flop (Q1). The output of the third flip-flop (Q1) is connected to the D input of the fourth flip-flop (Q0). The output of the fourth flip-flop (Q0) is connected to the D input of the first flip-flop (Q3), forming a circular shift register. The flip-flops are also connected to a common clock input C, which is inverted. The outputs Q3, Q2, Q1, and Q0 are shown as inverted signals. The power supply connections are specified as VCC1 = PIN 1, SCC2 = PIN 16, and VEE = PIN 8.

The MC10H141 is a four-bit universal shift register which performs shift left, or shift right, serial/parallel in, and serial/parallel out operations with no external gating. Inputs S1 and S2 control the four possible operations of the register without external gating of the clock. The flip-flops shift

information on the positive edge of the clock. The four operations are stop shift, shift left, shift right, and parallel entry of data. The other six inputs are all data type inputs; four for parallel entry data, and one for shifting in from the left (DL) and one for shifting in from the right (DR).

Device	Package	Shipping [†]
MC10H141FN	PLLC–20	46 Units / Rail
MC10H141FNG	PLLC–20 (Pb–Free)	46 Units / Rail
MC10H141FNR2	PLLC–20	500 / Tape & Reel
MC10H141FNR2G	PLLC–20 (Pb–Free)	500 / Tape & Reel
MC10H141L	CDIP–16	25 Unit / Rail
MC10H141P	PDIP–16	25 Unit / Rail
MC10H141PG	PDIP–16 (Pb–Free)	25 Unit / Rail

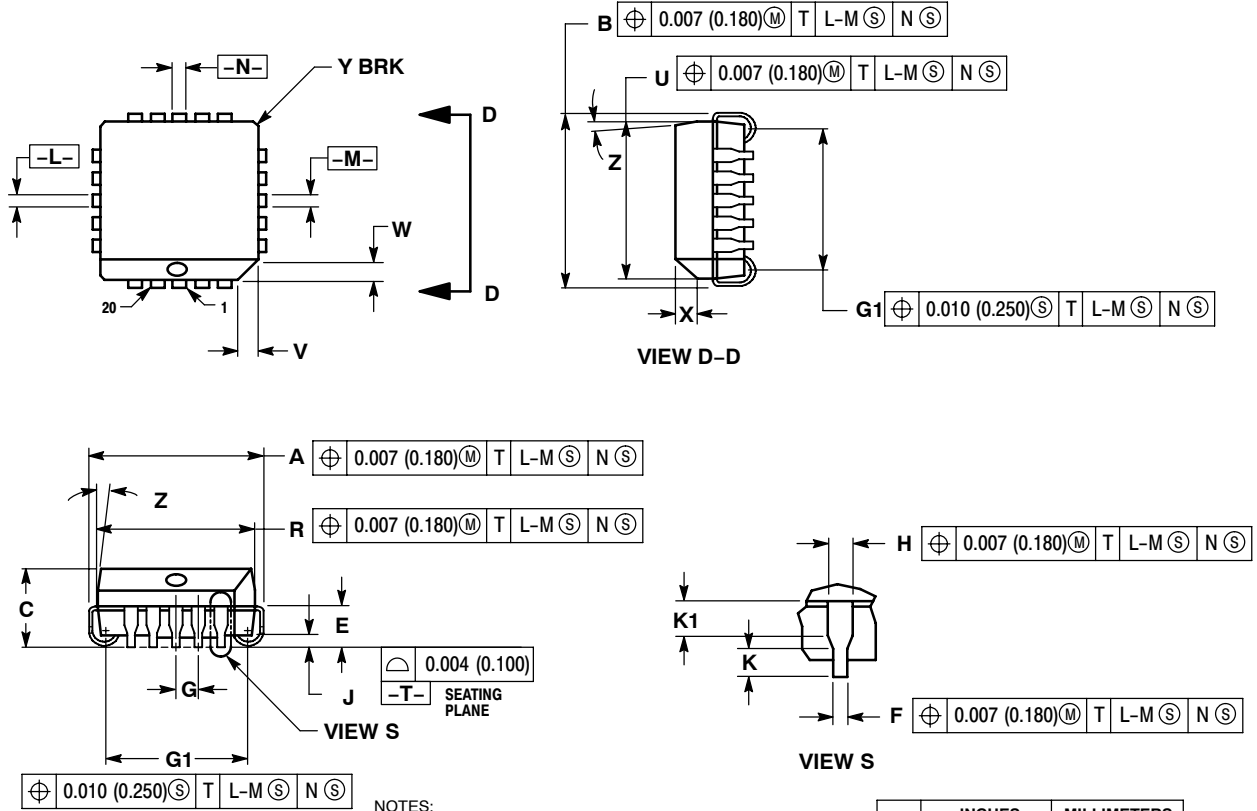
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MC10H141

[查询"MC10H141FNG"供应商](#)

PACKAGE DIMENSIONS

20 LEAD PLLC
CASE 775-02
ISSUE E



NOTES:

- DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982.
- DIMENSIONS IN INCHES.
- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

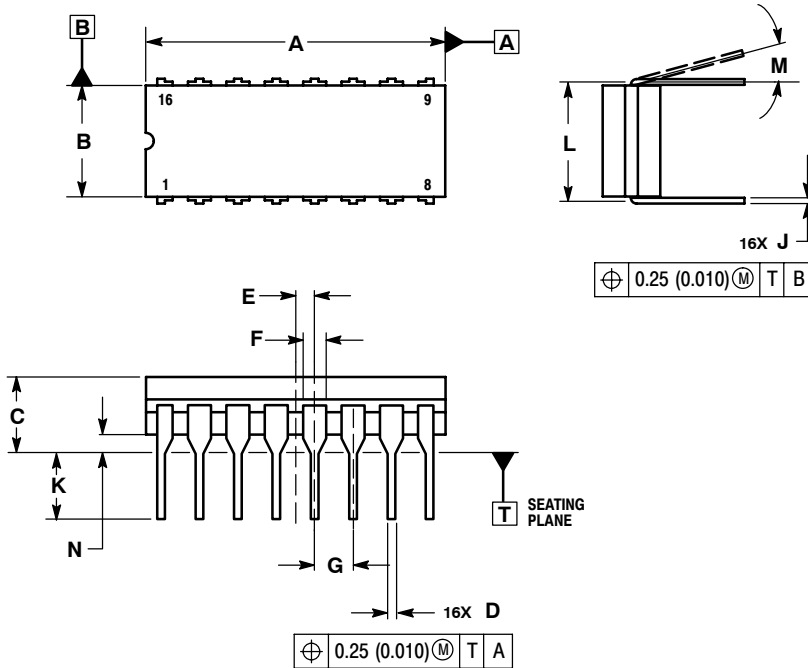
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2 °	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

MC10H141

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PACKAGE DIMENSIONS

CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620A-01 ISSUE O

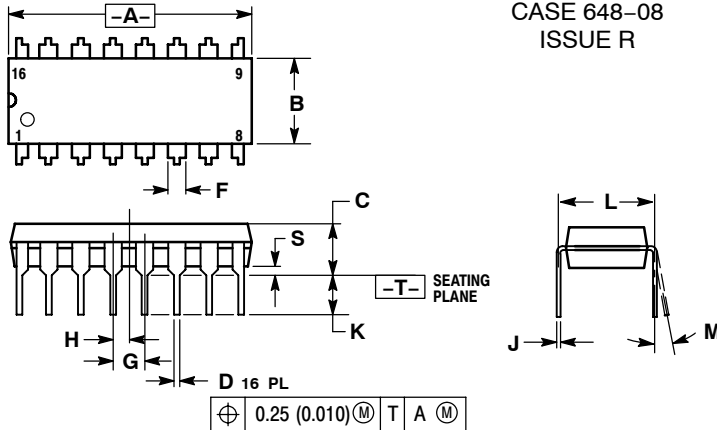


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.
5. THIS DRAWING REPLACES OBSOLETE CASE OUTLINE 620-10.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

PDIP-16 P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

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